

### SI7842DP-T1-GE3-VB Datasheet

## Dual N-Channel 30 V (D-S) MOSFET

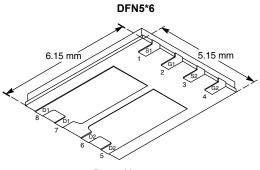
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) I <sub>D</sub> (A)					
30	0.018 at V <sub>GS</sub> = 10 V	22				

#### FEATURES

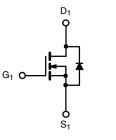
- Halogen-free According to IEC 61249-2-21
  Definition
- Trench Power MOSFET
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC

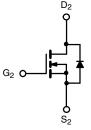


COMPLIANT HALOGEN FREE Available



Bottom View





N-Channel MOSFET

N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_A = 25 \text{ °C}$ , unless otherwise noted)							
Parameter		Symbol	10 s	Steady State	Unit		
Drain-Source Voltage		V <sub>DS</sub>	30		V		
Gate-Source Voltage	V <sub>GS</sub>	± 20		v			
Continuous Drain Current (T <sub>.I</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 25 °C	L_	22		А		
Continuous Drain Current $(T_j = 150^{\circ}C)$	T <sub>A</sub> = 70 °C	I <sub>D</sub>	15				
Pulsed Drain Current		I <sub>DM</sub>	50		A		
Continuous Source Current (Diode Conduction) <sup>a</sup>		۱ <sub>S</sub>	2.9		1		
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C	Р	3.5		W		
	T <sub>A</sub> = 70 °C	P <sub>D</sub>	2.2		vv		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C		
Soldering Recommendations (Peak Temperature)		2	60	U			

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
	$t \le 10 s$	R <sub>thJA</sub>	26	35		
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		60	85	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	3.9	5.5		

Notes:

a. Surface mounted on 1" x 1" FR4 board.

			B	<sup>⊪</sup> VBsem /Bsemi.co
	•		•	
ions	Min.	Тур.	Max.	Unit
250 μA	0.8		2.4	V
= ± 20 V			± 100	nA

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$ 0.8			2.4	V
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zara Cata Valtaga Drain Current		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$		1		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$			5	μA
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5$ V, $V_{GS}$ = 10 V	20			А
Drain Source On State Desistance	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$ $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 8.5 \text{ A}$		0.018		Ω
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>			0.024		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A		22		S
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_{S} = 2.9 \text{ A}, V_{GS} = 0 \text{ V}$		0.75	1.2	V
Dynamic <sup>b</sup>						
Total Gate Charge	Qg			13	20	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		2		nC
Gate-Drain Charge	Q <sub>gd</sub>			2.7		
Gate Resistance	Rg		0.5		3.2	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			8	16	
Rise Time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, \text{ R}_{L} = 15 \Omega$		10	20	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		21	40	ns
Fall Time	t <sub>f</sub>			10	20	
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 2.9 A, dl/dt = 100 A/μs		40	80	

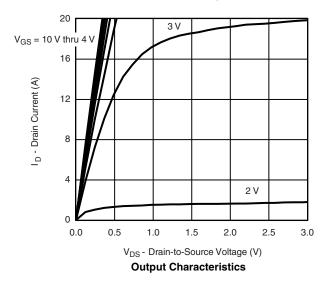
Notes:

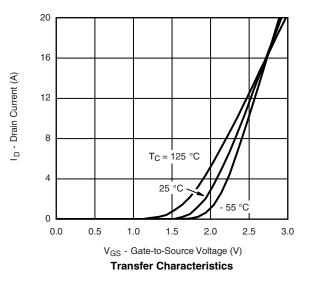
a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

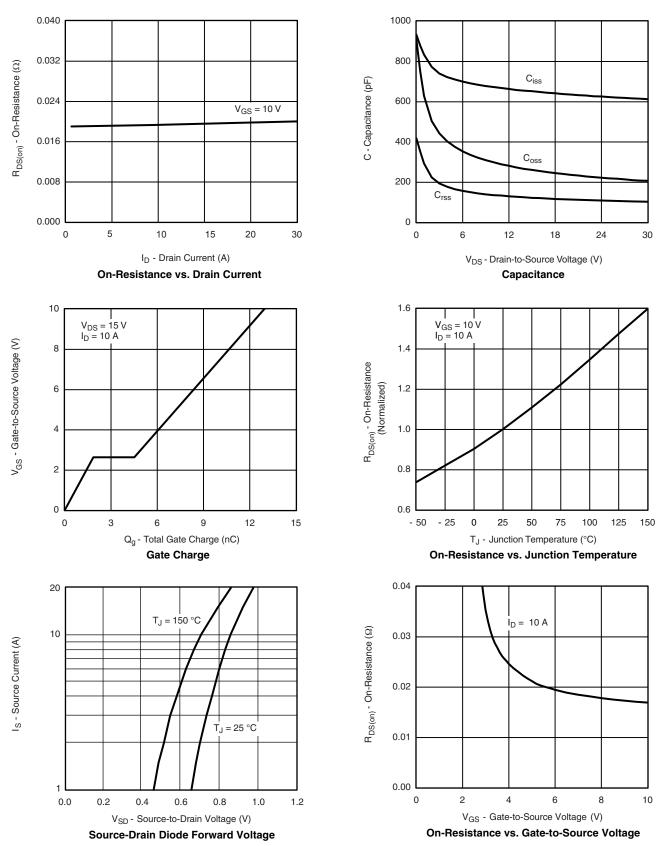
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







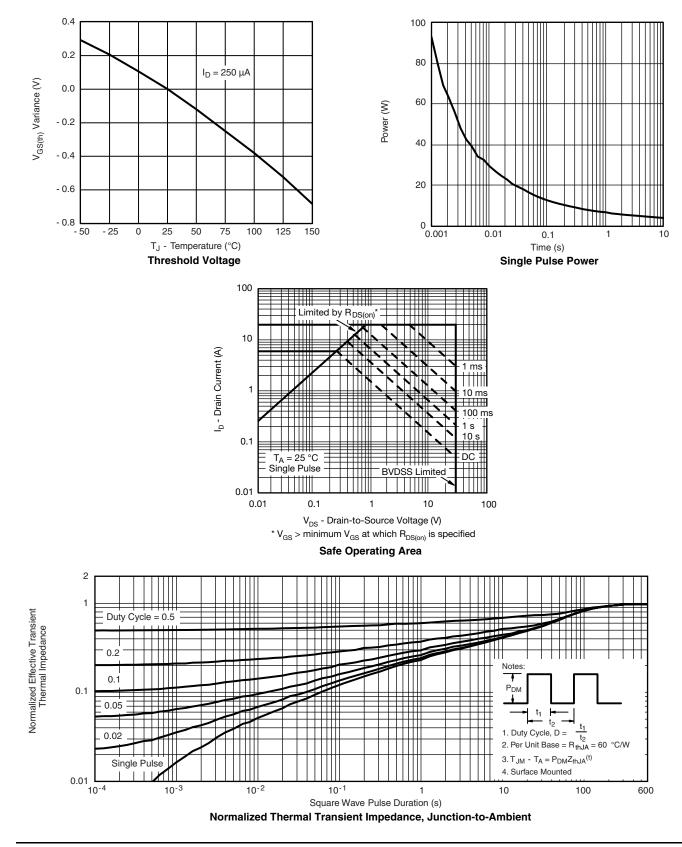
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服务热线:400-655-8788

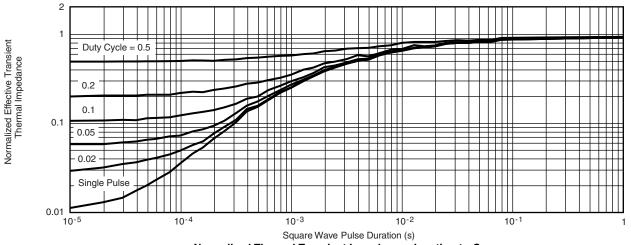








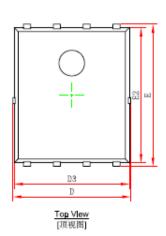
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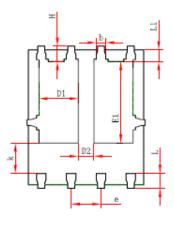


Normalized Thermal Transient Impedance, Junction-to-Case

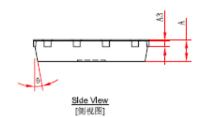


PDFNWB5×6-8L-A PACKAGE OUTLINE DIMENSIONS





<sup>&</sup>lt;u>Bottom Vlew</u> [背视图]



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	0.900	1.000	0.035	0.039	
A3	0.254	REF.	0.010	REF.	
D	4.944	5.096	0.195	0.201	
E	5.974	6.126	0.235	0.241	
D1	1.470	1.870	0.058	0.074	
D2	0.470	0.870	0.019	0.034	
E1	3.375	3.575	0.133	0.141	
D3	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
k	1.190	1.390	0.047	0.055	
b	0.350	0.450	0.014	0.018	
e	1.270	)TYP.	0.050TYP.		
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Н	0.574	0.726	0.023	0.029	
θ	10°	12°	10°	12°	

## SI7842DP-T1-GE3-VB



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